TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π–MOSV)

2SK2866

Chopper Regulator, DC-DC Converter and Motor Drive Applications

• Low drain-source ON resistance : $R_{DS}(ON) = 0.54 \Omega \text{ (typ.)}$

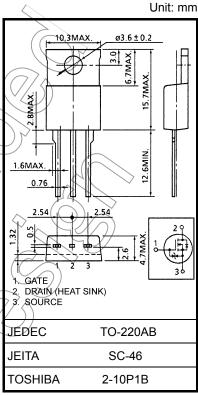
• High forward transfer admittance : $|Y_{fS}| = 9.0 \text{ S (typ.)}$

• Low leakage current : $I_{DSS} = 100 \mu A \text{ (max) (V}_{DS} = 600 \text{ V)}$

• Enhancement mode : V_{th} = 2.0 to 4.0 V (V_{DS} = 10 V, I_D = 1 mA)

Absolute Maximum Ratings (Ta = 25°C)

				/ \
Characteri	stics	Symbol	Rating	Unit
Drain-source voltage		V_{DSS}	600	$(\checkmark \checkmark)$
Drain-gate voltage (R	_{GS} = 20 kΩ)	V_{DGR}	600	A
Gate-source voltage		V_{GSS}	±30	×
Drain current	DC (Note 1)	ΙD	10	> A
	Pulse (Note 1)	I _{DP}	40	Α
Drain power dissipatio	n (Tc = 25°C)	PD	125	W
Single pulse avalanche	e energy (Note 2)	EAS	363	(mJ
Avalanche current		IAR)) 10	A
Repetitive avalanche	energy (Note 3)	EAR	12.5	mJ
Channel temperature		((T _{ch}))	150	∕\°C
Storage temperature ra	ange	T _{stg}	-55 to 150	°C



Weight: 1.9 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th} (ch-c)	1.0	°C / W
Thermal resistance, channel to ambient	Rth (ch-a)	83.3	°C / W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: V_{DD} = 90 V, T_{ch} = 25°C (initial), L = 6.36 mH, R_{G} = 25 Ω , I_{AR} = 10 A

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device.

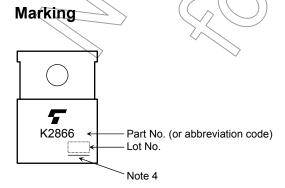
Please handle with caution.

Electrical Characteristics (Ta = 25°C)

Chara	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	urrent	I _{GSS}	V _{GS} = ±25 V, V _{DS} = 0 V	_	_	±10	μΑ
Gate-source br	eakdown voltage	V (BR) GSS	I _G = ±10 μA, V _{DS} = 0 V	±30	_	_	٧
Drain cut-off cu	ırrent	I _{DSS}	V _{DS} = 600 V, V _{GS} = 0 V		_	100	μΑ
Drain-source b	reakdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	600	_	_	٧
Gate threshold	voltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	2.0) }_	4.0	V
Drain-source O	N resistance	R _{DS} (ON)	V _{GS} = 10 V, I _D = 5 A	<u> </u>	0.54	0.75	Ω
Forward transfe	r admittance	Y _{fs}	V _{DS} = 10 V, I _D = 5 A	3.0	9.0	_	S
Input capacitano	ce	C _{iss}		_	2040	_	
Reverse transfer capacitance		C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz		210	_	pF
Output capacitance		Coss		_	630	_	
Switching time	Rise time	t _r	V_{GS} V_{OUT} V_{OUT}	- (22	<u>\</u>	
	Turn-on time	t _{on}	$\begin{array}{c} 0V \\ \hline \end{array} \begin{array}{c} R_L \\ \hline \end{array} = 40\Omega$		58) –	
	Fall time	t _f		7	36	_	ns
	Turn-off time	t _{off}	$V_{DD} = 200V$ Duty $\leq 1\%$, $t_{W} = 10\mu s$) -	190	_	
Total gate charg	ge (gate-source)	Qg		_	45	_	
Gate-source ch	arge	Q _{gs}	$V_{DD} \approx 400 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 10 \text{ A}$	_	25	_	nC
Gate-drain ("mi	ller") Charge	Q _{gd}		_	20	_	

Source-Drain Ratings and Characteristics (Ta = 25°C)

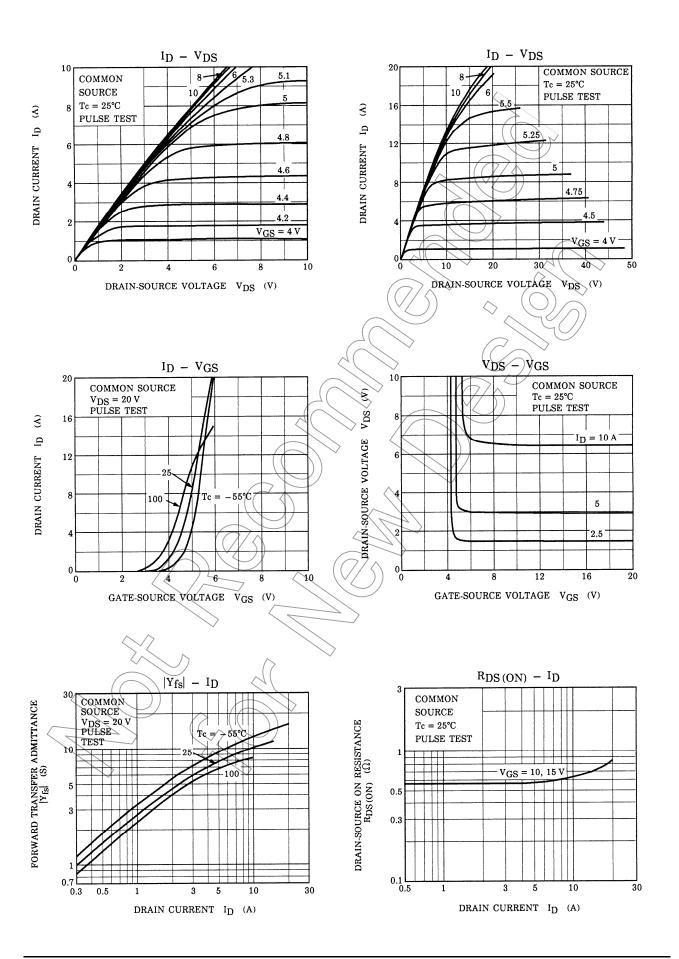
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	lóR		_	_	10	Α
Pulse drain reverse current (Note 1)	\ I _{DRP}	_	_	_	40	Α
Forward voltage (diode)	V_{DSF}	I _{DR} = 10 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	t _{rr}	I _{DR} = 10 A, V _{GS} = 0 V	_	1300	_	ns
Reverse recovery charge	Qrr	dl _{DR} / dt = 100 A / μs		16	_	μC



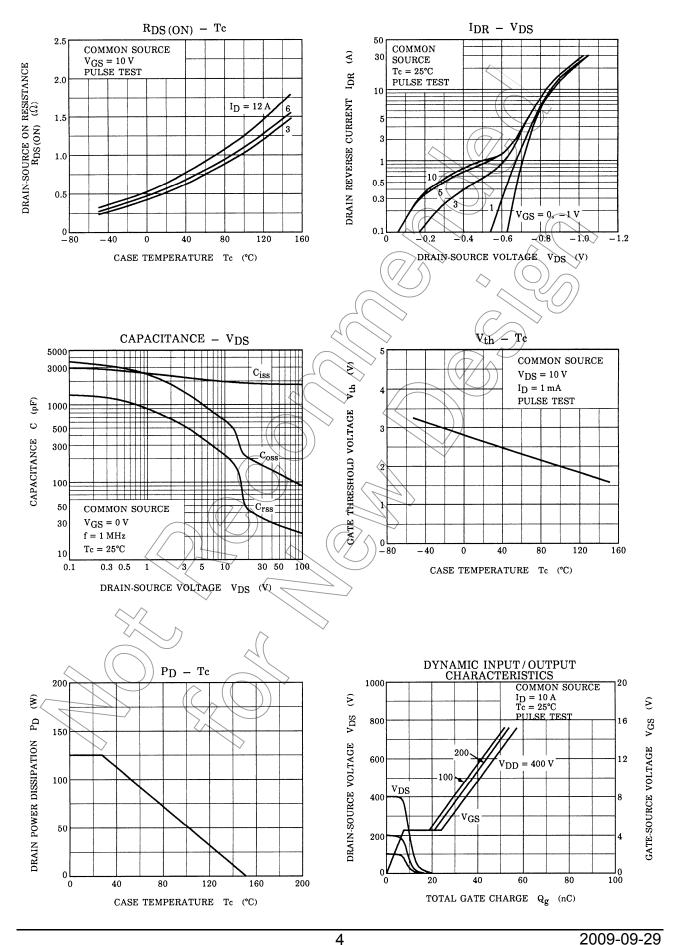
Note 4: A line under a Lot No. identifies the indication of product Labels.

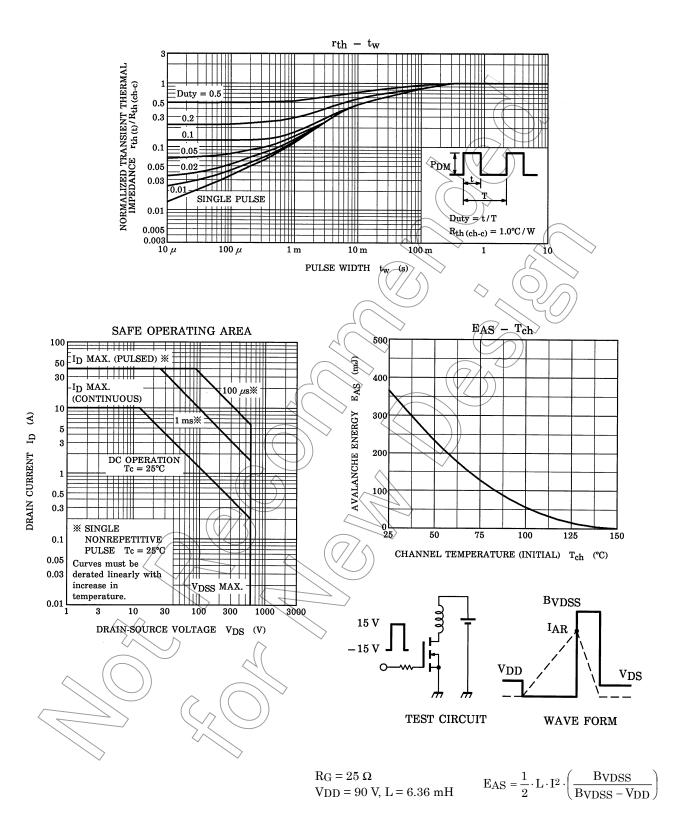
Not underlined: [[Pb]]/INCLUDES > MCV Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.



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